

# Proton Radiation Damage Experiment for X-Ray Pixel Detectors Keigo Yarita (Tokyo University of Science),

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We have been developing XRPIX which is a monolithic active pixel sensor based on Silicon On Insulator (SOI) CMOS technology for future satellites. XRPIX has time resolution shorter than 10 micro seconds. Furthermore, XRPIX has similar energy resolution to the CCDs because of small parasitic capacitance owing to SOI technology.

In low earth orbit, there are many cosmic rays which are composed primarily of high energy protons. By interacting with the cosmic rays, semiconductor detectors are damaged, and their performance such as energy resolution gets worse. Thus, to examine their radiation hardness is one of important issues.

We used heavy ion accelerator at National Institute of Radiological Science in Chiba to perform our proton radiation damage experiment for XRPIX. We irradiate 6MeV proton to XRPIX2bFZ. With 410rad irradiation, whose equivalent time in orbit is 3.5 years, degradations of gain and energy resolution are less than 0.2% and 0.5%, respectively. After more proton irradiation, specifically at 4000rad, gain increases by 0.7% and energy resolution gets worse by 10% than those with no damage. In addition, we found out that damage of source follower increased fluctuation of output and this is one of cause which worsened energy resolution.



In the space radiation environment, performances of semiconductor detectors degrade year by year due to lattice detect or total ionizing dose. Lattice defect or Total Ionizing Dose (TID) is suspected as the reason for this. We fear that XRPIX is suffered by the same effect, so we have to assess quantitatively and investigate damage mechanism.



Detector	XRPIX 2b FZ	
Sensor	500 µm	
Thickness		
Pixel Size	30 µm × 30 µm	
Pixel Number	$144 \times 144$	
Resistivety	5.0 kΩ∙cm	
Proton didn't go through XRPIX.		
But proton beam irradiated from XRPIX's		
thin circuit layer, so we could damage		
sensor layer as well as circuit layer.		

μm	Table2: irradiation conditions	
ŀ	Place	HIMAC
ו	Proton Energy	6 MeV
	Back Bias Voltage	150 V
<b>;</b>	Integration Time	100 µs
	Irradiated from sensor layer	

# Result

One of our purpose is XRPIX can endure 3.5 years operation. So, we report from two aim. One of them is 410 rad whose equivalent time in orbit is 3.5 years, and the other is hard damaged 4000rad.

Back Bias Voltage	250 V
Integration Time	100 µs



## **Bad Pixel Fraction**

We defined bad pixel as the pixel whose output differ 3sigma from average of all pixel's output. Bad pixel fraction was only 1~2% until 4000 rad. Since 10000 rad, the fraction increased rapidly.

### • Orad 100rad 410rad 1000rad 4000rad 10000rad 12000rad

### Energy Spectrum

We irradiated <sup>109</sup>Cd X-ray from sensor layer when we examined the XRPIX's performance. This is spectrum of Single Pixel Event. Peak at 170 ch is AgKa characteristic X-ray.

## Leak current





leak current increased rapidly to 5 times.

And inclination became steeply since 4000 rad. Focus on gain at Vbb = 250 V, rate of increase was only 0.2 % at 410 rad. Significant difference is showed up at 4000 rad but the rate was no more than 0.7 %.



Figure3: Energy spectra at Vbb 250V

After 4000 rad, we removed some from evaluation because too large fluctuation of pedestal impeded bad pixel selection.



Figure4: Bad Pixel fraction to all pixel number

We could isolate noise to use these expressions.

 $\sigma^2 = \sigma_{\text{Readout}}^2 + \sigma_{\text{Fano}}^2$  $\sigma_{\text{Readout}}^2 = \sigma_{\text{leakcurrent}}^2 + \sigma_{\text{circuit}}^2$ But we couldn't recreate FWHM from these expressions, so we introduced other term.

 $\sigma^2 = \sigma_{\text{leakcurrent}}^2 + \sigma_{\text{circuit}}^2 + \sigma_{\text{Fano}}^2 + \sigma_{\text{other}}^2$ We show this result in left figure. The figure tells us increasing circuit noise made energy resolution worse. Therefore, an arbitrary voltage was applied to only a part of the circuit, and it was verified whether the output changes with the route.

By comparing with each of various route output, we can detect a cause of increasing circuit noise.

Orad 20000rad route2 route1 route3

In route2 and 3, the level of output became lower after damage. Radiation damage made fluctuation of route1

## **Noise decomposition**

Figure8: Transition of every kind of noise

OUT BUF

# Conclusion

- XRPIX2b's performance like gain or energy resolution didn't show significant different at 410 rad whose equivalent in orbit is 3.5 years.
- After 4000 rad, leak current and energy resolution showed significant different.
- By comparing of each circuit output, circuit noise increases at source follower.